

# Sun, Jingdong

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## EDUCATION

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<b>Missouri University of Science &amp; Technology (Missouri S&amp;T)</b> Ph.D. Candidate in Electrical and Computer Engineering	<i>Aug. 2016-Present</i> GPA: 4.0/4.0
<b>Missouri University of Science &amp; Technology (Missouri S&amp;T)</b> M.S. in Electrical and Computer Engineering	<i>Aug. 2014-May. 2016</i> GPA: 4.0/4.0
<b>Huazhong University of Science &amp; Technology (HUST)</b> B.S. in Electronics and Information Engineering (Honor Program)	<i>Sept. 2010-Jun. 2014</i> GPA: 3.7/4.0

## HONORS AND AWARDS

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<b>IEEE EMC Society Best Student EMC Hardware Design Award</b> First Author. Granted by IEEE Electromagnetic Compatibility Society.	<i>Mar. 2015</i>
<b>Exceptional Performance in the International EM Proficiency Test</b> Top 4% among 265 exam takers from Japan, HK, Korea, Taiwan, and U.S.	<i>Oct. 2014</i>
<b>Graduate Research Assistant Scholarship</b> Full research scholarship granted by EMC Laboratory, Missouri S&T.	<i>Sept. 2014</i>
<b>National Prize in Mathematical Modeling Contest CUMCM</b> Top 5% among all the participates from China, Singapore, and U.S.	<i>Sept. 2012</i>

## WORKING EXPERIENCE

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<b>ConvenientPower Systems (CPS), Leading in Wireless Charging</b> Manager, RX System Group (14 members)	<i>Apr. 2017-Aug. 2018</i> <i>Chengdu, China</i>
<ul style="list-style-type: none"><li>· Provided IC-based wireless power receiver solutions for mobile phones &amp; accessories.</li><li>· Solution for MEIZU POP TWS Earpods is the world's 1<sup>st</sup> earphones certified by WPC Qi standard.</li><li>· Brought the 1<sup>st</sup> 10W fast wireless charging function to mobile phone GIONEE M7P in China.</li></ul>	
<b>H3C Technologies Co., Ltd.</b> Software Engineer	<i>May. 2011-Jan. 2013</i> <i>Wuhan, China</i>
<ul style="list-style-type: none"><li>· Software development (C/C++) in user space and kernel for Linux-based router system.</li><li>· Followed CMM dev methodology, completed HLD and UT cases. Deployed GTest environment.</li><li>· Implemented network quality analyzer for multi-protocols based on C for H3C Comware platform.</li></ul>	

## RESEARCH

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**Areas of Interests:** signal integrity, wireless power transfer, device modeling, network algorithm.

**Publications:** 5 peer-reviewed journals and conference papers.

**Presentations:** 1 talk and 1 poster on CEMC IAB Meeting in 2016 and 2014.

### Academic Projects

· Simulation of HPM / ESD Effects on Semiconductor Device	<i>Sept. 2016-Apr. 2017</i>
· Resonance Wireless Power System for Multiple Receiver Devices	<i>May. 2015-Apr. 2016</i>
· Automated Channel Emulator Based on MEMS Switch	<i>Sept. 2014-Apr. 2016</i>

- Wireless Smoke Detection Based on Structure Similarity of Video Feb. 2014-Jun. 2014
- Optimal Bandwidth Allocation Algorithm for VoD Streaming Nov. 2013-Nov. 2015
- Huawei Heat Sink / IC Field Transformation Jul. 2013-Oct. 2013

## SKILLS

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### Hardware

Schematic, PCB layout, embedded system  
ARM, FPGA, Xilinx Zynq, Intel Galileo

### Measurement

Oscilloscope, VNA, SA, TDR measurement  
Near-field scanning, and micro-probing

### Software

C/C++, Perl, Python, Matlab, HTML/CSS, PHP,  
Javascript, TCL/Tk, Verilog, Vim/Emacs, LaTeX

### Simulation

RF simulation: HFSS, CST, EMC Studio  
Circuit simulation: ADS, HSPICE

Last updated: November 16, 2018